



THE ENGINEERING SOCIETY OF BUFFALO, INC.

2023 Scholarship Application

WNY School _____ SUNY Buffalo (UB) _____ Erie Community College
Attending _____ Buffalo State College _____ Other (Specify below) _____

Anticipated State Date _____ Major _____

1. Applicant Name _____

Residence _____

Home Phone _____ Mobil Phone _____

Email _____ Place of Birth _____ Date of Birth _____

First Parent/Guardian Name _____ Deceased? _____

Employer _____ Occupation _____

Same Address as Applicant?

Address _____

Second Parent/Guardian Name _____ Deceased? _____

Employer _____ Occupation _____

Same Address as Applicant?

Address _____

Siblings Living at Home (Include name, age, and list either pre-school, attending school, working, etc.) _____



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2. High School
Name _____

Address _____

Dates of Attendance _____

SAT or ACT Score _____

Other Awarded Scholarships _____

Total Amount \$ _____

Extracurricular School Activities (Include average hours per week) _____

Offices Held _____

Awards/honors Obtained _____

Activities Outside of School Such as Civic Affairs, Volunteer, Religious, Etc. (Include average hours per week) _____



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3. Please attach the answers to the following questions when sending in your application:
 - a) Explain Any Employment While in High School (Include average hours per week).
 - b) What Kind of Reading Do You Enjoy?
 - c) What Type of Entertainment Do you Prefer?
 - d) What Are Your Hobbies?
 - e) Why Do You Want to be an Engineer? (In 200 words or less)
 - f) Who is your favorite living engineer? Why is this engineer your favorite?

4. You must include with your application the following required attachments:
 - a) College acceptance letter
 - b) 3 ½ years high school transcripts and class rank
 - c) Recommendation letter from your school STEM teacher
 - d) The 6 questions above listed in section 3

PDF Attachments: Please respond to scholarship questions listed on this application in Sections 3 and 4 by attaching a separate PDF. **Note that all attachments may not exceed 10MB.**

Applicant Signature / Date _____

Parent/Guardian Signature / Date _____

SUBMIT APPLICATION TO (On or before June 1, 2023):

Patrick Conway – Scholarship Chairman – piccpe@aol.com

The Engineering Society of Buffalo, Inc. – ESB1894@gmail.com